

S12MD1V/S12MD3

Photothyristor Coupler

* Lead forming type (I type) and taping reel type (P type) of S12MD1V are also available. (S12MD1VI/S12MDIP)

■ Features

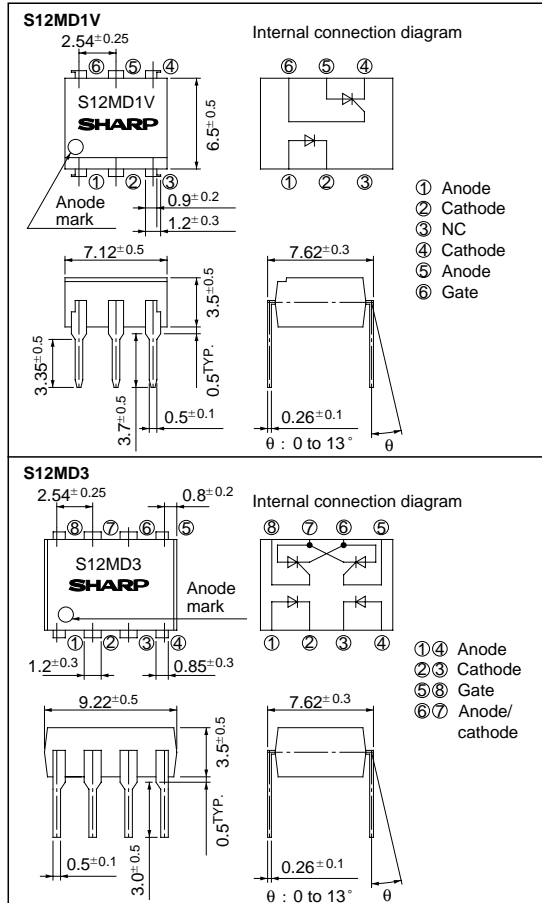
1. High RMS ON-state current (I_T : MAX. 200mA_{rms})
 2. High repetitive peak OFF-state voltage (V_{DRM} : MIN. 400V)
 3. Trigger current I_{FT} : MAX. 15mA at $R_G = 20k\Omega$
 4. (For half-wave control ... S12MD1V)
(For full-wave control ... S12MD3)
 5. Recognized by UL, file No. E64380
- * S12MD1V and S12MD3 are for 100V line

■ Applications

1. ON-OFF operation for a low power load
2. For triggering high power thyristor and triac

■ Outline Dimensions

(Unit : mm)



■ Absolute Maximum Ratings

(Ta = 25°C)

Parameter	Symbol	Rating		Unit	
		S12MD1V	S12MD3		
Input	Forward current	I _F	50	mA	
	Reverse voltage	V _R	6	V	
Output	RMS ON-state current	I _T	200	mA _{rms}	
	*1 Peak one cycle surge current	I _{surge}	2	A	
	*2 Repetitive peak OFF-state voltage	V _{DRM}	400	V	
	*2 Repetitive peak reverse voltage	V _{RRM}	400	-	V
	*3 Isolation voltage	V _{iso}	5 000	1 500	V _{rms}
	Operating temperature	T _{opr}	- 30 to + 100	°C	
	Storage temperature	T _{stg}	- 40 to + 125	°C	
	*4 Soldering temperature	T _{sol}	260	°C	

*1 50Hz, sine wave *3 40 to 60% RH, AC for 1 minute
 *2 R_G = 20kΩ *4 For 10 seconds

■ Electro-optical Characteristics

(Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V _F I _F = 30mA	-	1.2	1.4	V
	Reverse current	I _R V _R = 3V	-	-	10 ⁻⁵	A
Output	Repetitive peak OFF-state current	I _{DRM} V _{DRM} = Rated, R _G = 20kΩ	-	-	10 ⁻⁶	A
	*5 Repetitive peak reverse current	I _{RRM} V _{RRM} = Rated, R _G = 20kΩ	-	-	10 ⁻⁶	A
	ON-state voltage	V _T I _T = 200mA	-	1.0	1.4	V
	Holding current	I _H V _D = 6V, R _G = 20kΩ	-	0.3	1	mA
	Critical rate of rise of OFF-state voltage	dV/dt V _{DRM} = 1/√2 Rated, R _G = 20kΩ	3	-	-	V/μs
Transfer-characteristics	Minimum trigger current	I _{FT} V _D = 6V, R _L = 100Ω, R _G = 20kΩ	-	-	15	mA
	Isolation resistance	R _{ISO} DC500V, 40 to 60% RH	5 x 10 ¹⁰	10 ¹¹	-	Ω
	Turn-on time	t _{on} V _D = 6V, I _F = 30mA, R _G = 20kΩ, R _L = 100Ω	-	10	60	μs

*5 Applies only to S12MD1V

Fig. 1 RMS ON-state Current vs. Ambient Temperature

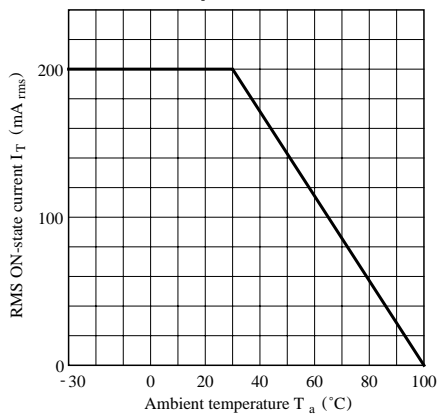


Fig. 2 Forward Current vs. Ambient Temperature

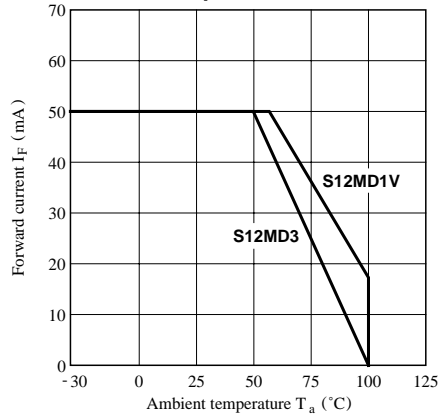


Fig. 3 Forward Current vs. Forward Voltage

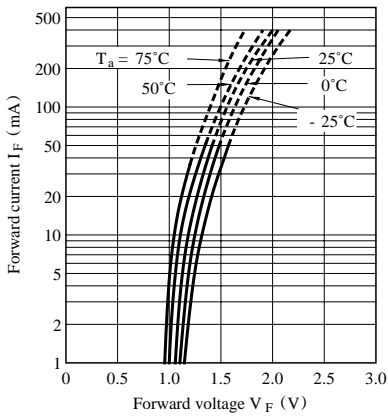


Fig. 4 Minimum Trigger Current vs. Ambient Temperature

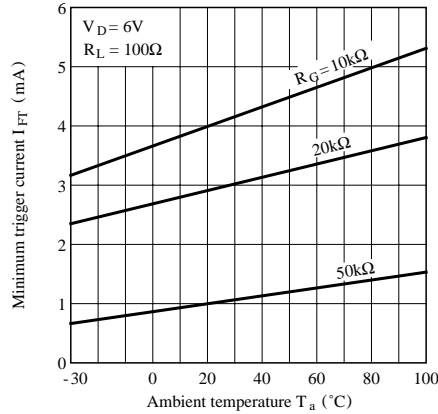


Fig. 5 Minimum Trigger Current vs. Gate Resistance

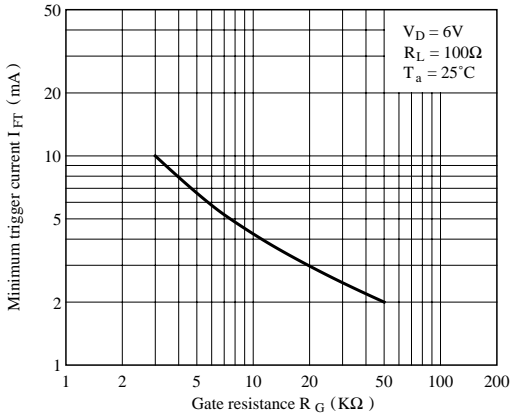


Fig. 6 Break Over Voltage vs. Ambient Temperature

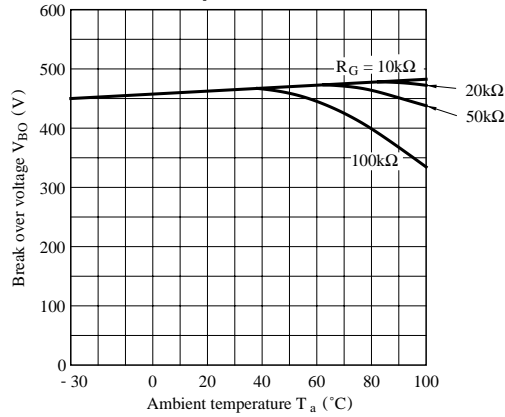


Fig. 7 Critical Rate of Rise of OFF-state Voltage vs. Ambient Temperature

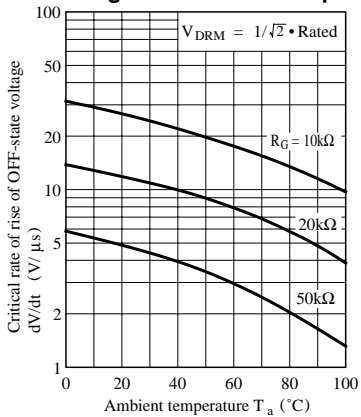


Fig. 8 Holding Current vs. Ambient Temperature

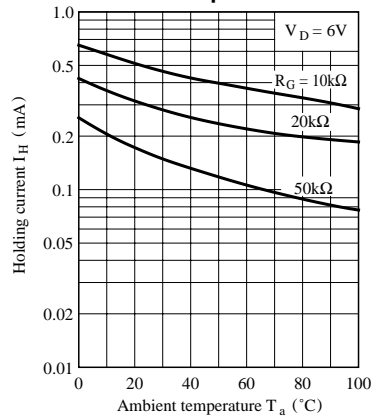
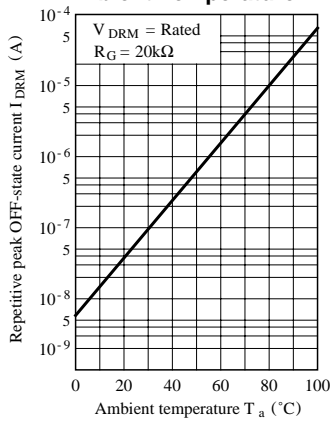


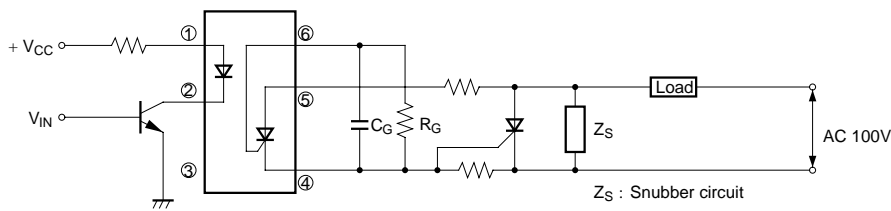
Fig. 9 Repetitive Peak OFF-state Current vs. Ambient Temperature



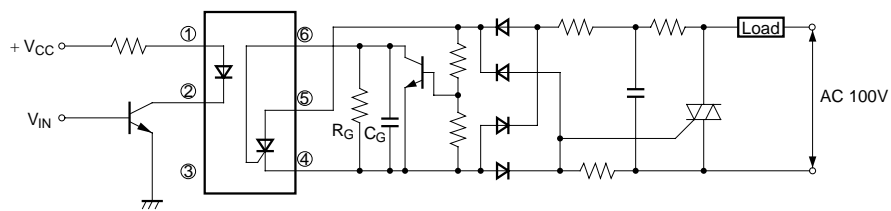
Basic Operation Circuit

● S12MD1V

Medium/High Power Thyristor Drive Circuit

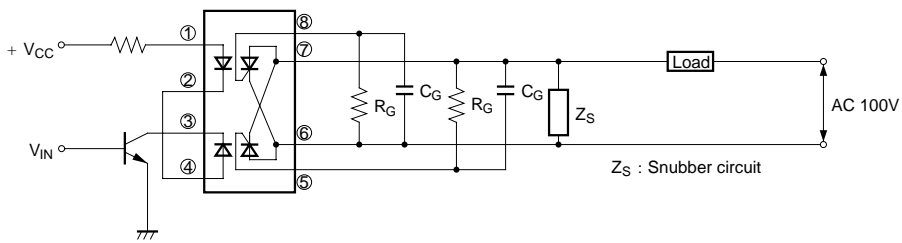


Medium/High Power Triac Drive Circuit (Zero-cross Operation)

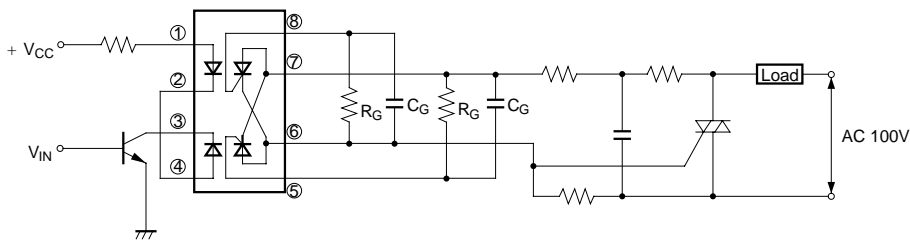


● S12MD3

Low Power Load Drive Circuit



Medium/High Power Triac Drive Circuit



- Please refer to the chapter “Precautions for Use” (Page 78 to 93).

Application Circuits

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